isola

Tachyon® 100G

Ultra Low Loss Laminate and Prepreg Tg 200°C Td 360°C Dk 3.02 Df 0.0021

IPC-4103 /17 IPC-4101 /102 UL - File Number E41625

Tachyon 100G laminate materials are designed for very high-speed digital applications up to and beyond data rates of 100 Gb/s.

PRODUCT FEATURES

Industry Recognition

- UL File Number: E41625
- RoHS Compliant

Performance Attributes

- CAF resistant
- Low moisture absorption
- 0.8 mm pitch capable
- 6x 260°C reflow capable
- 6x 288°C solder float capable

Processing Advantages

- Multiple lamination cycles
- HDI technology compatible

PRODUCT AVAILABILITY

- Standard Material Offering: Laminate
 - 2 to 18 mil (0.05 to 0.46 mm)

Copper Foil Type

- HVLP (VLP2) 12.5 micron Rz JIS, 1 oz and below is standard
- RTF (Reverse Treat Foil)

Copper Weight

- ½, 1 oz (18 and 35 μm) available
- Thinner copper foil available

Standard Material Offering: Prepreg

• Moisture barrier packaging Glass Fabric Availability

- Low Dk Class Acabi, Ja
- Low Dk Glass -Asahi Japan, Asahi Tawian, TGI Taiwan
- Square weave glass
- Mechanically spread glass

ORDERING INFORMATION:

Contact your local sales representative or contact info@isola-group.com for further information.

Tachyon 100G materials exhibit exceptional electrical properties that are very stable over a broad frequency and temperature range between -55°C and +125°C up to 100 GHz. These electrical properties provide designers a scalable solution for next generation designs of backplanes and daughter cards, enabling 10x improvements from 10 Gb/s data rates.

Isola has developed Tachyon 100G with the highest level of thermal performance for high layer count line cards. The very low Z-axis CTE makes it a perfect choice for fine pitch BGA applications of 0.8 mm or less. The material is optimized with the use of spread glass to mitigate skew, improve rise times, reduce jitter, and increase eye width/height and that use ultra smooth HVLP (VLP2) 2um Rz copper that significantly reduces conductor losses.

PRODUCT ATTRIBUTES







TYPICAL MARKET APPLICATIONS



AEROSPACE & DEFENSE

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Typical Values Table

	Property	Typical Value	Units Metric (English)	Test Method IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		200	°C	2.4.25C
Glass Transition Temperature (Tg) by DSG		220	°C	2.4.24.4
Glass Transition Temperature (Tg) by TMA		180	°C	2.4.24C
Decomposition Temperature (Td) by TGA @ 5% weight loss		360	°C	2.4.24.6
	A. T260	>60	Minutes	2.4.24.1
Time to Delaminate by TMA (Copper removed)	B. T288	>60		
	C. T300	>20		
Z-Axis CTE	A. Pre-Tg	45	ppm/°C ppm/°C %	2.4.24C
	B. Post-Tg	250		
	C. 50 to 260°C, (Total Expansion)	2.5		
X/Y-Axis CTE	Pre-Tg	15	ppm/°C	2.4.24C
Thermal Conductivity		0.42	W/m·K	ASTM E1952
Thermal Stress 10 sec @ 288°C (550.4°F)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	A. @ 2 GHz	3.04	-	2.5.5.5
	B. @ 5 GHz	3.02		
	C. @ 10 GHz	3.02		
Df, Loss Tangent	A. @ 2 GHz B. @ 5 GHz	0.0021	-	2.5.5.5
	в. (µ 5 GHz С. (@ 10 GHz	0.0021		
Volume Resistivity	C-96/35/90	1.33x10 ⁷	MØ-cm	2.5.17.1
Surface Resistivity	C-96/35/90	1.33x10 ⁵	M	2.5.17.1
Dielectric Breakdown		60	kV	2.5.6B
Arc Resistance		125	Seconds	2.5.1B
Electric Strength (Laminate & laminated prepreg)		60 (1500)	kV/mm (V/mil)	2.5.6.2A
Comparative Tracking Index (CTI)		3	Class (Volts)	UL 746A ASTM D3638
Peel Strength	A. Low profile copper foil and very low profile copper foil all copper foil >17 Im [0.669 mil]	0.79 (4.5)	N/mm (lb/inch)	2.4.8C
	B. Standard profile copper 1. After thermal stress	0.96 (5.5)		2.4.8.2A
Flexural Strength	A. Length direction B. Cross direction	44.0 41.0	ksi	2.4.4B
Tensile Strength	A. Length direction B. Cross direction	30.0 25.0	ksi	ASTM D3039
Young's Modulus	A. Length direction B. Cross direction	2,551 2,417	ksi	ASTM D790-15e2
Taylor's Modulus	A. Length direction B. Cross direction	2,264 2,197	ksi	ASTM D790-15e2
Poisson's Ratio	A. Length direction B. Cross direction	0.165 0.156	-	ASTM D3039
Moisture Absorption		0.1	%	2.6.2.1A
Flammability (Laminate & laminated prepreg)		V-0	Rating	UL 94
Relative Thermal Index (RTI)		130	°C	UL 796

NOTES

Visit our site http://www.isola-group.com for more details. Revisions:

- A: Initial release 4/17
- B: Corrected moisture uptake value 6/18
- C: Corrected units for Flexural and Tensile Strength 8/18
- D: Change MOT to RTI 5/19
- E: Changed VLP2 to HVLP to aligned with common industry terms 4/21

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